

MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			80	V	
V _{GS}	Gate to Source Voltage			±20	V	
I _D	Drain Current -Continuous (Package limited)	T _C = 25°C		22		
	-Continuous (Silicon limited)	T _C = 25°C		48	•	
	-Continuous	T _A = 25°C	(Note 1a)	8.8	Α	
	-Pulsed			50		
D	Power Dissipation	T _C = 25°C		78		
P _D	Power Dissipation	T _A = 25°C	(Note 1a)	2.5		
T _J , T _{STG}	Operating and Storage Junction Temperature R	lange		-55 to +150	°C	

Thermal Characteristics

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FDMS3572

$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.6	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/W

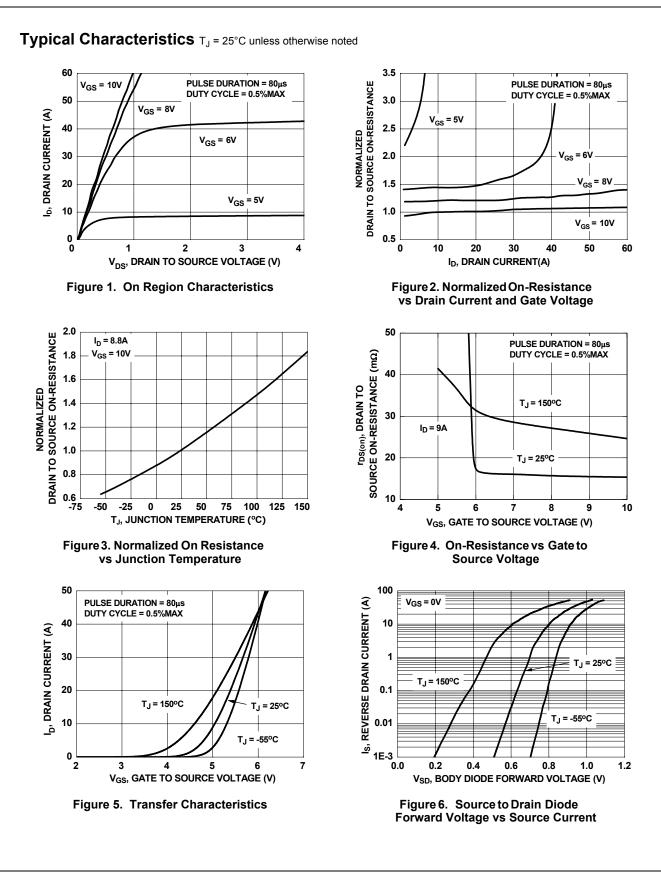
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS3572	FDMS3572	Power 56	13"	12mm	3000 units

February 2007

	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					1
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	80			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu$ A, referenced to 25°C		76		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 64V, V_{GS} = 0V$			1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20V, V_{DS} = 0V			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250μA	2	3.2	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250\mu$ A, referenced to 25°C		-11		mV/°C
-		V _{GS} = 10V, I _D = 8.8A		13.5	16.5	
r _{DS(on)}	Drain to Source On Resistance	V _{GS} = 6V, I _D = 8.4A		18.3	24	mΩ
		V_{GS} = 10V, I_{D} = 8.8A, T_{J} = 125°C		22.2	29	
9 _{FS}	Forward Transconductance	V _{DS} = 10V, I _D = 8.8A		23		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance			1870	2490	pF
C _{oss}	Output Capacitance	$V_{\rm DS}$ = 40V, $V_{\rm GS}$ = 0V,		275	365	pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		78	120	pF
R _g	Gate Resistance	f = 1MHz		1.3		Ω
	g Characteristics					
t _{d(on)}	Turn-On Delay Time			11	20	ns
t _r	Rise Time	$-V_{DD} = 40V, I_D = 8.8A$ $-V_{GS} = 10V, R_{GEN} = 6\Omega$		13	24	ns
t _{d(off)}	Turn-Off Delay Time	GS TOV, TGEN 012		24	39	ns
t _f	Fall Time			12	22	ns
Q _{g(TOT)}	Total Gate Charge at 10V	$V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 40V$		28	40	nC
Q _{gs}	Gate to Source Gate Charge	I _D = 8.8A		9		nC
Q _{gd}	Gate to Drain "Miller" Charge			8		nC
Drain-Soເ	arce Diode Characteristics					
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 8.8A$ (Note 2)		0.8	1.2	V
t _{rr}	Reverse Recovery Time	I _F = 8.8A, di/dt = 100A/μs		43	65	ns
Q _{rr}	Reverse Recovery Charge			71	107	nC

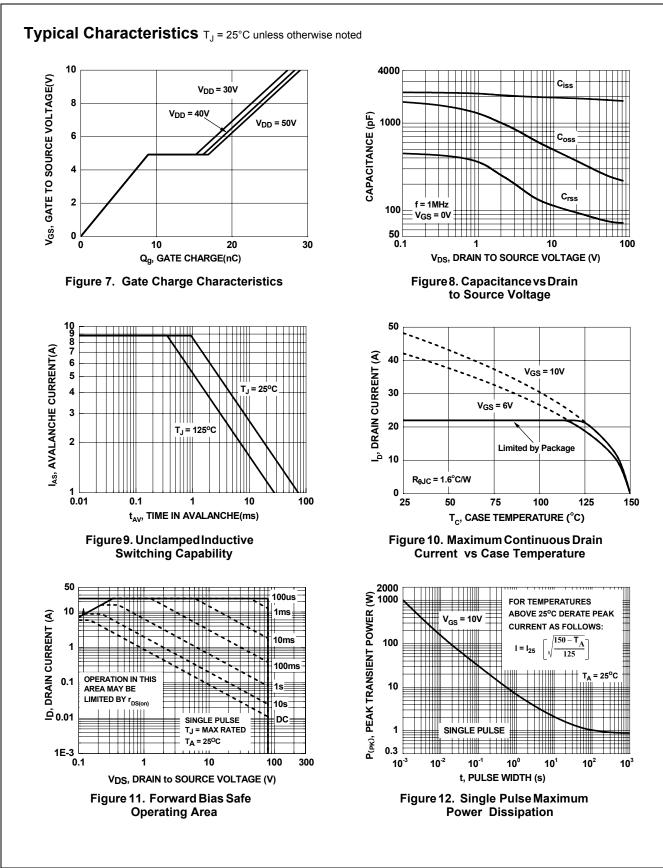
2: Pulse Test: Pulse Width < 300μ s, Duty cycle < 2.0%.



FDMS3572 Rev.C1

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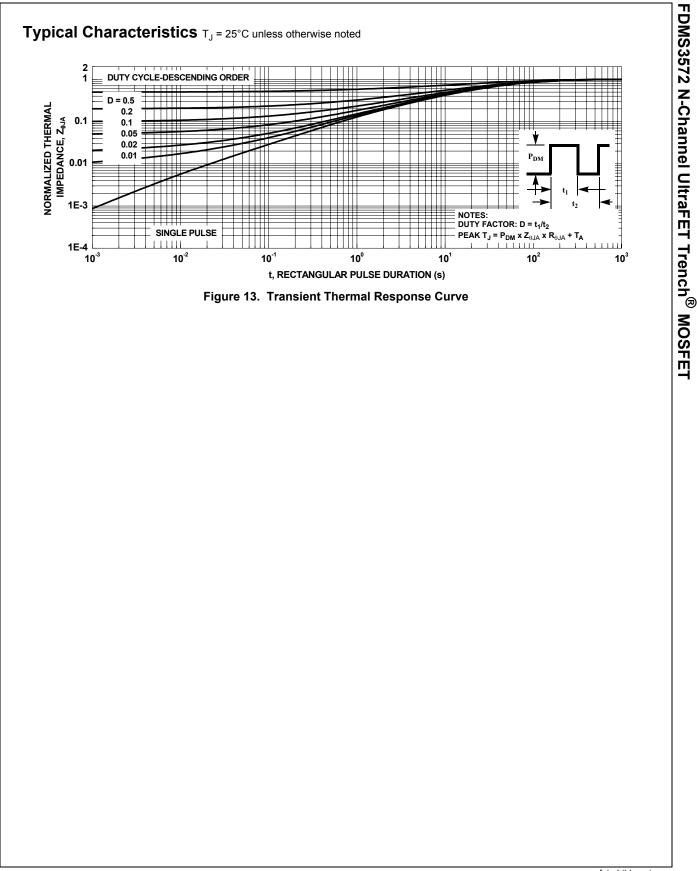




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___0.10 C 2X 5.0 A -0.77Ð 8 5 X 4.52 6.0 6.61 4.32 3.91-4 0.10 C 2X 1 PIN #1 IDENT -TOP VIEW 0.61 TYP. 1.27 TYP -0.8 MAX RECOMMENDED LAND PATTERN // 0.10 C (0.25)C 0.08 C ¢ 0.05 0.00 SIDE VIEW SEATING PLANE 3.86 <u>@</u> 3.66 0.64 0.44 PIN #1 IDENT (OPTIONAL) 3.42 3.22 4.01? .10 5 1.27 0.36-0.46 🚯 ⊕ 0.10 M C A B 3.81 0 ⊕ 0.05 M C BOTTOM VIEW NOTES: ODES NOT FULLY CONFORM TO JEDEC REGISTRATION, MO-229. DATED 11/2001. B. DIMENSIONS ARE IN MILLIMETERS. C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994 D. TERMINALS 5,6,7 AND 8 ARE TIED TO THE EXPOSED PADDLE MLP08GrevD

FDMS3572 N-Channel UltraFET Trench[®] MOSFET

FDMS3572 Rev.C1

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